

Sound Processor with Built-in 3-band Equalizer

BD37543FS

General Description

BD37543FS is a sound processor with built-in 3-band equalizer for car audio. The functions are stereo input selector (which can switch single and ground isolation input), input-gain control, main volume, loudness, 5ch fader volume, LPF and HPF for subwoofer and mixing input. Moreover, "Advanced switch circuit", which is an original ROHM technology, can reduce various switching noise (ex. No-signal, low frequency like 20Hz & large signal inputs). Also, "Advanced switch" makes control of microcomputer easier, and can construct a high quality car audio system.

Features

- Reduced switching noise of input gain control, mute, main volume, fader volume, bass, middle, treble, loudness, mixing by using advanced switch circuit.
- Built-in differential input selector that can make various combination of single-ended / differential input.
- Built-in ground isolation amplifier inputs, which is ideal for external stereo input.
- Built-in input gain controller reduces switching noise for volume of a portable audio input.
- Decreased number of external components due to built-in 3-band equalizer filter, LPF for subwoofer, and HPF. It is possible to control Q, G_V, f_O of 3-band equalizer, and f_C of LPF/HPF through the I²C BUS control.
- It is possible to adjust the gain of the bass, middle, treble up to ±20dB with 1 dB step gain adjustment.
- It is equipped with output terminals for Subwoofer. Moreover, the stereo signal output of the front and rear can also be chosen by the I²C BUS control.
- Built-in mixing input and mixing attenuator.
- Energy-saving design resulting in low-current consumption is achieved by utilizing the Bi-CMOS process. It has the advantage in quality over scaling down the power heat control of the internal regulators.
- Input terminals and output terminals are organized and separately laid out to keep the signal flow in one direction which results in simpler and smaller PCB layout.
- It is possible to control the I²C BUS by 3.3V / 5V.

Applications

It is optimal for car audio systems. It can also be used for audio equipment of mini Compo, micro Compo, TV, etc.

Key Specifications

■ Power Supply Voltage Range: 7.0V to 9.5V
 ■ Circuit Current (No Signal): 38mA (Typ)

■ Total Harmonic Distortion 1:

(FRONT,REAR) 0.001%(Typ)

Total Harmonic Distortion 2:

(SUBWOOFER) 0.002%(Typ)

Maximum Input Voltage: 2.3Vrms (Typ)

Cross-talk Between Selectors: -100dB (Typ)

Volume Control Range: +15 dB to -79dB

Output Noise Voltage 1:

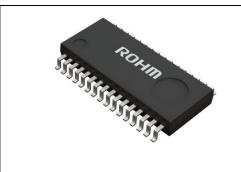
(FRONT,REAR) 3.8µVrms(Typ)

Output noise voltage 2:

(SUBWOOFER) 4.8μVrms(Typ)
Residual Output Noise Voltage: 1.8μVrms(Typ)
Operating Temperature Range: -40°C to +85°C

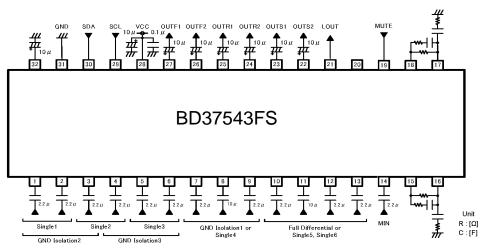
Package

 $W(Typ) \times D(Typ) \times H(Max)$



SSOP-A32 13.60 mm x 7.80mm x 2.01mm

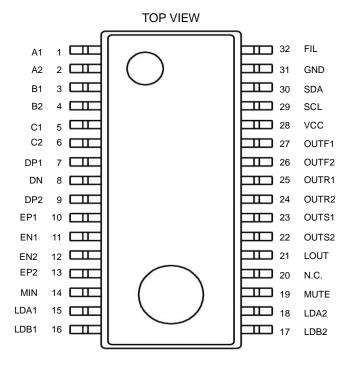
Typical Application Circuit



Pin Configuration

% About single input 1 to 3, it is possible to change from single input to GND Isolation input 2,3.

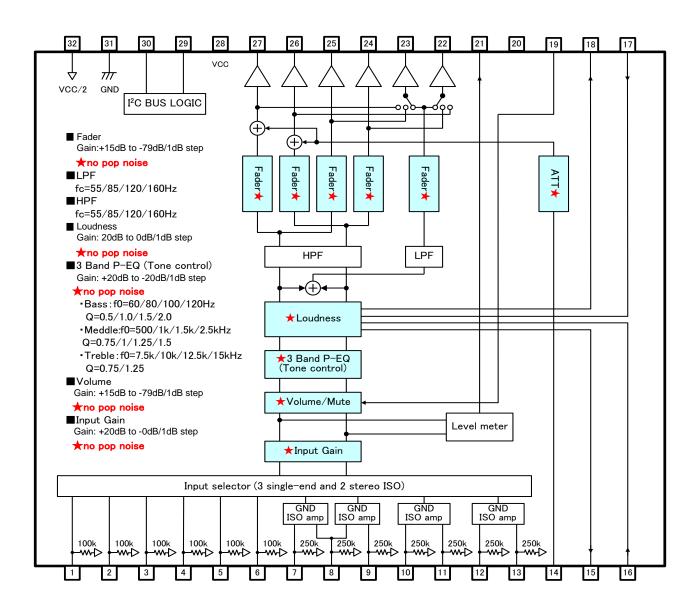
% About GND Isolation1 and Full Differential, it is possible to change from differential input to single input 4 to 6.



Pin Descriptions

A2 A input terminal of 2ch B1 B input terminal of 1ch B2 B input terminal of 2ch C1 C input terminal of 2ch C2 C input terminal of 1ch DP1 D positive input terminal B DN D D positive input terminal of 2ch DP2 D positive input terminal of 2ch DP3 D positive input terminal of 2ch DP4 D positive input terminal of 2ch DP5 D positive input terminal DR6 DP6 D positive input terminal DR7 D D positive input terminal DR8 D D D D positive input terminal DR9 DP7 D positive input terminal DR9 DP8 D positive input terminal of 2ch DR9 DP9 D positive input terminal of 1ch DR9 DP9 DP9 DP9 DP9 DP9 DP9 DP9 DP9 DP9 DP					
Pin No.	Pin Name	Description	Pin No.	Pin Name	
1	A1	A input terminal of 1ch	17	LDB2	Loudness setting terminal of 2ch
2	A2	A input terminal of 2ch	18	LDA2	Loudness setting terminal of 2ch
3	B1	B input terminal of 1ch	19	MUTE	External compulsory mute terminal
4	B2	B input terminal of 2ch	20	N.C.	No Connection
5	C1	C input terminal of 1ch	21	LOUT	Output terminal for Level meter
6	C2	C input terminal of 2ch	22	OUTS2	Subwoofer output terminal of 2ch
7	DP1	D positive input terminal of 1ch	23	OUTS1	Subwoofer output terminal of 1ch
8	DN	D negative input terminal	24	OUTR2	Rear output terminal of 2ch
9	DP2	D positive input terminal of 2ch	25	OUTR1	Rear output terminal of 1ch
10	EP1	E positive input terminal of 1ch	26	OUTF2	Front output terminal of 2ch
11	EN1	E negative input terminal of 1ch	27	OUTF1	Front output terminal of 1ch
12	EN2	E negative input terminal of 2ch	28	VCC	Power supply terminal
13	EP2	E positive input terminal of 2ch	29	SCL	I ² C Communication clock terminal
14	MIN	Mixing input terminal	30	SDA	I ² C Communication data terminal
15	LDA1	Loudness setting terminal of 1ch	31	GND	GND terminal
16	LDB1	Loudness setting terminal of 1ch	32	FIL	VCC/2 terminal

Block Diagram



Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit
Power Supply Voltage	Vcc	10.0	٧
Input Voltage	Vin	Vcc+0.3 to GND-0.3	V
Power Dissipation	Pd	0.95 (Note 1)	W
Storage Temperature	Tstg	-55 to +150	°C

⁽Note 1) When mounted on the standard board (70 x 70 x 1.6 mm³), derate by 7.6mW/°C for Ta above 25°C.

Thermal resistance 6ja = 131.6(°C/W)

Material: A FR4 grass epoxy board(3% or less of copper foil area

Caution: Operating the IC over the absolute maximum ratings may damage the IC. The damage can either be a short circuit between pins or an open circuit between pins and the internal circuitry. Therefore, it is important to consider circuit protection measures, such as adding a fuse, in case the IC is operated over the absolute maximum ratings.

Recommended Operating Conditions

Parameter	Symbol	Min	Тур	Max	Unit
Power Supply Voltage	Vcc	7.0	-	9.5	V
Temperature	Topr	-40	-	+85	°C

Electrical Characteristics

(Unless specified, Ta=25°C, Vcc=8.5V, f=1kHz, V_{IN}=1Vrms, Rg=600 Ω , R_L=10k Ω , A1 input, Input gain 0dB, Mute OFF, Volume 0dB, Tone control 0dB, Loudness 0dB, LPF OFF, HPF OFF, Mixing OFF, Fader 0dB)

Volume dab, Tone control dab, Loudness dab, LPF OFF, HPF OFF, Mixing OFF, Fader dab) Limit									
Š	Parameter	Symbol		Limit		Unit	Conditions		
BLOCK	i aiailietei	Symbol	Min	Тур	Max	Offic	Conditions		
	Circuit Current (No Signal)	IQ	-	38	48	mA	No signal		
	Voltage Gain	G∨	-1.5	0	+1.5	dB	G _V =20log(V _{OUT} /V _{IN})		
	Channel Balance	СВ	-1.5	0	+1.5	dB	$CB = G_{V1} - G_{V2}$		
	Total Harmonic Distortion 1 (FRONT,REAR)	THD+N1	-	0.001	0.05	%	V _{OUT} =1Vrms BW=400Hz-30KHz		
	Total Harmonic Distortion 2 (SUBWOOFER)	THD+N2	-	0.002	0.05	%	V _{OUT} =1Vrms BW=400Hz-30KHz		
GENERAL	Output Noise Voltage 1 (FRONT,REAR) *	V _{NO1}	-	3.8	15	μVrms	$Rg = 0\Omega$ BW = IHF-A		
GENE	Output Noise Voltage 2 (SUBWOOFER) *	V _{NO2}	-	4.8	15	μVrms	$Rg = 0\Omega$ BW = IHF-A		
	Residual Output Noise Voltage *	V_{NOR}	-	1.8	10	μVrms	Fader = -∞dB Rg = 0Ω BW = IHF-A		
	Cross-talk Between Channels *	СТС	-	-100	-90	dB	Rg = 0Ω CTC= $20log(V_{OUT}/V_{IN})$ BW = IHF-A		
	Ripple Rejection	RR	-	-70	-40	dB	f=1kHz V _{RR} =100mVrms RR=20log(V _{CC} IN/V _{OUT})		
	Input Impedance(A, B,C)	R _{IN_S}	70	100	130	kΩ			
~	Input Impedance(D, E)	R_{IN_D}	175	250	325	kΩ			
ECTOF	Maximum Input Voltage	V _{IM}	2.1	2.3	ı	Vrms	V _{IM} at THD+N(V _{OUT})=1% BW=400Hz-30KHz		
INPUT SELECTOR	Cross-talk Between Selectors *	CTS	-	-100	-90	dB	Rg = 0Ω CTS= $20log(V_{OUT}/V_{IN})$ BW = IHF-A		
	Common Mode Rejection Ratio*	CMRR	50	65	-	dB	XP1 and XN input XP2 and XN input CMRR=20log(V _{IN} /V _{OUT}) BW = IHF-A,[*XD,E]		

Electrical Characteristics - continued

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Š	D	Oh. al		Limit		1.1	0
BLOCK	Parameter	Symbol	Min	Тур	Max	Unit	Conditions
SAIN	Minimum Input Gain	GIN_MIN	-2	0	+2	dB	Input gain 0dB V _{IN} =100mVrms G _{IN} =20log(V _{OUT} /V _{IN})
NPUT GAIN	Maximum Input Gain	G _{IN_MAX}	18	20	22	dB	Input gain 20dB V _{IN} =100mVrms G _{IN} =20log(V _{OUT} /V _{IN})
_	Gain Set Error	G _{IN_ERR}	-2	0	+2	dB	GAIN=+1dB to +20dB
MUTE	Mute Attenuation *	G _М UТЕ	-	-105	-85	dB	Mute ON $G_{MUTE}=20log(V_{OUT}/V_{IN})$ $BW = IHF-A$
	Maximum Gain	Gv_max	13	15	17	dB	Volume = 15dB V_{IN} =100mVrms G_V =20log(V_{OUT}/V_{IN})
VOLUME	Maximum Attenuation *	G _{V_MIN}	-	-100	-85	dB	Volume = -∞dB Gv=20log(V _{OUT} /V _{IN}) BW = IHF-A
0	Attenuation Set Error 1	Gv_err1	-2	0	+2	dB	GAIN & ATT=+15dB to -15dB
	Attenuation Set Error 2	G _{V_ERR2}	-3	0	+3	dB	ATT=-16dB to -47dB
	Attenuation Set Error 3	G _{V_ERR3}	-4	0	+4	dB	ATT=-48dB to -79dB
	Maximum Boost Gain	G _{B_BST}	18	20	22	dB	Gain=+20dB f=100Hz V _{IN} =100mVrms G _B =20log (V _{OUT} /V _{IN})
BASS	Maximum Cut Gain	G в_сит	-22	-20	-18	dB	Gain=-20dB f=100Hz V _{IN} =2Vrms G _B =20log (V _{OUT} /V _{IN})
	Gain Set Error	G _{B_ERR}	-2	0	+2	dB	Gain=-20dB to +20dB f=100Hz
щ	Maximum Boost Gain	G м_вѕт	18	20	22	dB	Gain=+20dB f=1kHz V _{IN} =100mVrms G _M =20log (V _{OUT} /V _{IN})
MIDDLE	Maximum Cut Gain	G м_сит	-22	-20	-18	dB	Gain=-20dB f=1kHz V _{IN} =2Vrms G _M =20log (V _{OUT} /V _{IN})
	Gain Set Error	G _{M_ERR}	-2	0	+2	dB	Gain=-20dB to +20dB f=1kHz
Щ	Maximum Boost Gain	G _{T_BST}	18	20	22	dB	Gain=+20dB f=10kHz V _{IN} =100mVrms GT=20log (V _{OUT} /V _{IN})
TREBLE	Maximum Cut Gain	G т_сит	-22	-20	-18	dB	Gain=-20dB f=10kHz V _{IN} =2Vrms GT=20log (V _{OUT} /V _{IN})
	Gain Set Error	G _{T_ERR}	-2	0	+2	dB	Gain=-20dB to +20dB f=10kHz
	Input Impedance	R _{IN_M}	19	27	35	kΩ	
DN DS	Maximum Input Voltage	V _{IM_M}	2.0	2.2	-	Vrms	V _{IM} at THD+N(V _{OUT})=1% BW=400Hz-30KHz
MIXING	Maximum Attenuation	G _{MX_MIN}	-	-100	-85	dB	MIX=OFF G _{MX} =20log(V _{OUT} /V _{IN}) BW=INF-A
	Maximum Gain	Gмх_мах	5	7	9	dB	ATT=+6dB G _{MX} =20log(V _{OUT} /V _{IN})

Electrical Characteristics - continued

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BLOCK	Parameter	Symbol		Limit		Unit	Conditions
BLC	Faiametei	Symbol	Min	Тур	Max	Offic	Conditions
	Maximum Boost Gain	G _{F_BST}	13	15	17	dB	Fader=15dB V _{IN} =100mVrms G _F =20log(V _{OUT} /V _{IN})
SUBWOOFER	Maximum Attenuation *	G _{F_MIN}	-	-100	-90	dB	Fader = -∞dB G _F =20log(V _{OUT} /V _{IN}) BW = IHF-A
BWC	Gain Set Error	G _{F_ERR}	-2	0	+2	dB	GAIN=+1dB to +15dB
l SU	Attenuation Set Error 1	G _{F_ERR1}	-2	0	+2	dB	ATT=-1dB to -15dB
-ADER	Attenuation Set Error 2	G _{F_ERR2}	-3	0	+3	dB	ATT=-16dB to -47dB
FAC	Attenuation Set Error 3	GF_ERR3	-4	0	+4	dB	ATT=-48dB to -79dB
	Output Impedance	Rout	-	-	50	Ω	V _{IN} =100mVms
	Maximum Output Voltage	Vом	2	2.2	-	Vrms	THD+N=1% BW=400Hz-30KHz
LOUDNESS	Maximum Gain	G _{L_MAX}	17	20	23	dB	Gain 20dB V _{IN} =100mVrms G _L =20log(V _{OUT} /V _{IN})
LOU	Gain Set Error	G _{L_ERR}	-2	0	+2	dB	Gain=+1dB to +20dB
meter	Maximum Output Voltage	V _{L_MAX}	2.8	3.1	3.5	V	
Level meter	Output Offset Voltage	V _{L_OFF}	-	0	100	mV	

VP-9690A(Average value detection, effective value display) filter by Matsushita Communication is used for * measurement. Phase between input / output is same.

Typical Performance Curves

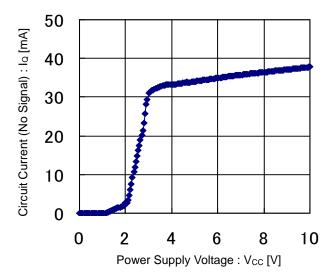


Figure 1. Circuit Current (No Signal) vs Power Supply Voltage

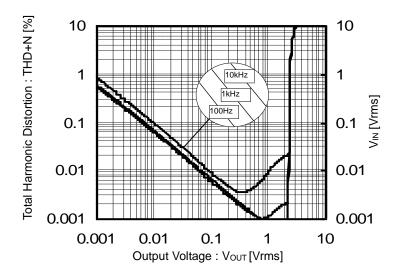


Figure 2. Total Harmonic Distortion vs Output Voltage

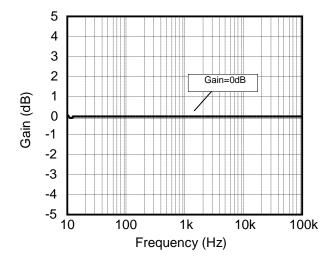


Figure 3. Gain vs Frequency

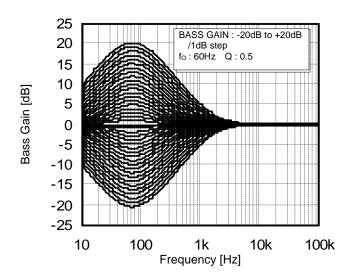


Figure 4. Bass Gain vs Frequency

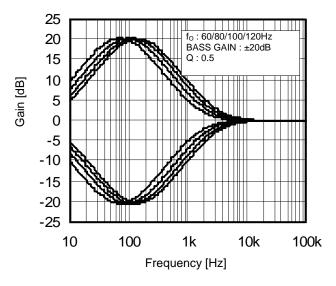


Figure 5. Bass fo vs Frequency

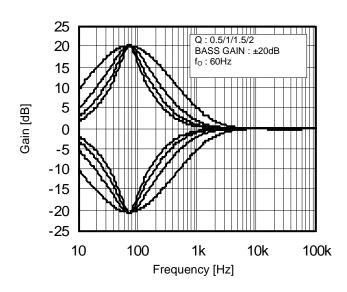


Figure 6. Bass Q vs Frequency

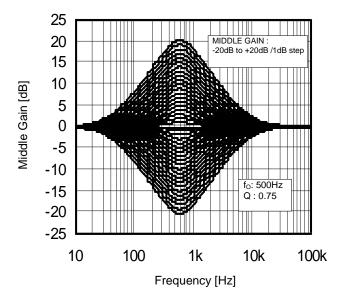


Figure 7. Middle Gain vs Frequency

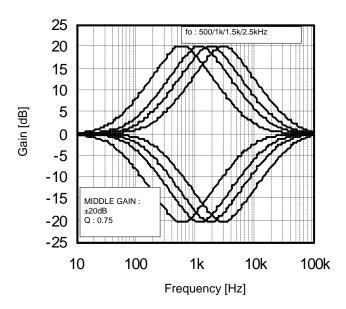


Figure 8. Middle fo vs Frequency

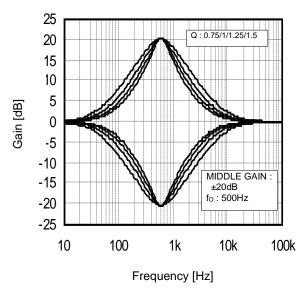


Figure 9. Middle Q vs Frequency

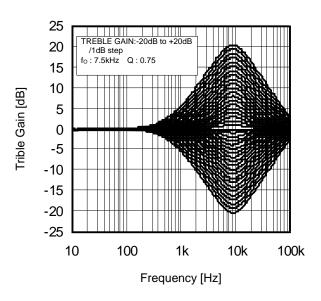


Figure 10. Treble Gain vs Frequency

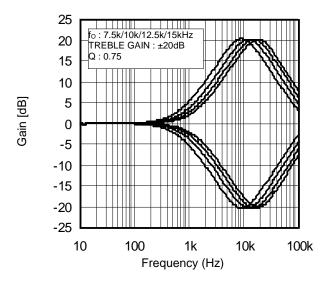


Figure 11. Treble fo vs Frequency

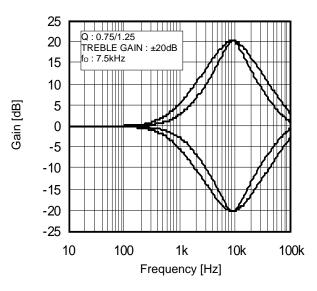


Figure 12. Treble Q vs Frequency

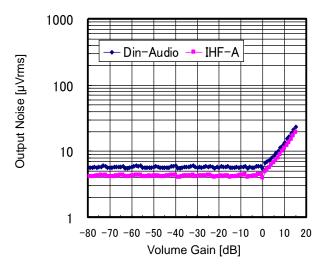


Figure 13. Output Noise vs Volume Gain

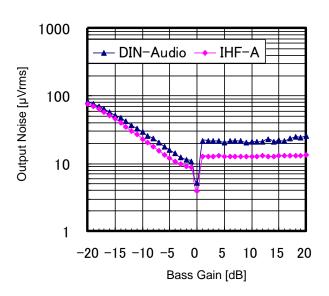


Figure 14. Output Noise vs Bass Gain

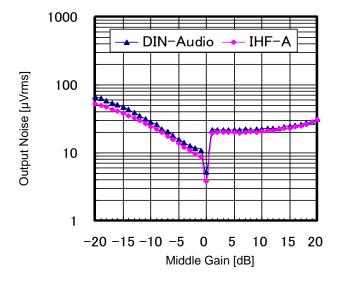


Figure 15. Output Noise vs Middle Gain

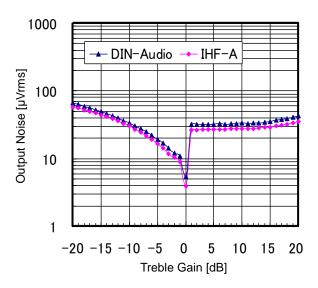


Figure 16. Output Noise vs Treble Gain

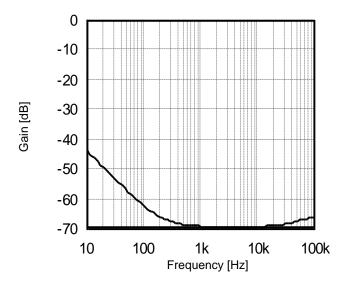


Figure 17. CMRR vs Frequency

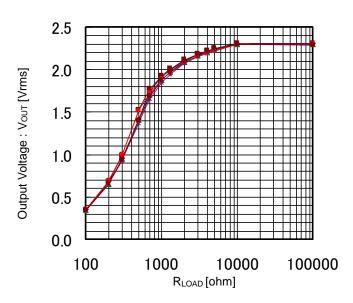


Figure 18. Output Voltage vs RLOAD

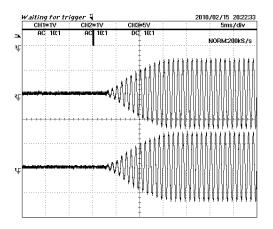


Figure 19. Advanced Switch 1

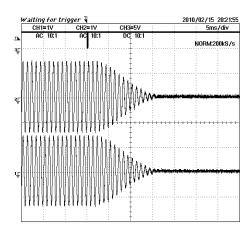


Figure 20. Advanced Switch 2

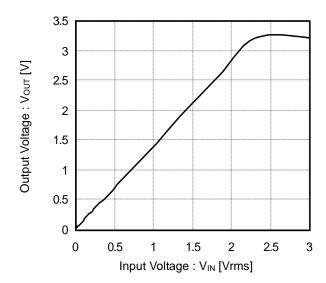


Figure 21. Output Voltage vs Input Voltage (Level Meter V_{IN})

Timing Chart CONTROL SIGNAL SPECIFICATION

(1) Electrical Specifications and Timing for Bus Lines and I/O Stages

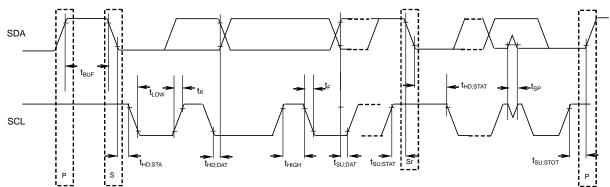


Figure 22. I2C-bus Signal Timing Diagram

Table 1 Characteristics of the SDA and SCL bus lines for I2C-bus devices (Ta=25°C, Vcc=8.5V)

	Parameter	Symbol	Fast-mode	e I ² C-bus	Unit
	Falametei	Symbol	Min	Max	Offic
1	SCL clock frequency	fscL	0	400	kHz
2	Bus free time between a STOP and START condition	t BUF	1.3	-	μS
3	Hold time (repeated) START condition. After this period, the first clock	4	0.6		c
3	pulse is generated	t _{HD;STA}	0.6	-	μS
4	LOW period of the SCL clock	tLOW	1.3	-	μS
5	HIGH period of the SCL clock	thigh	0.6	-	μS
6	Set-up time for a repeated START condition	t _{SU;STA}	0.6	-	μS
7	Data hold time:	t _{HD;DAT}	0.06 ^(Note)	-	μS
8	Data set-up time	tsu;dat	120	-	ns
9	Set-up time for STOP condition	tsu;sto	0.6	-	μS

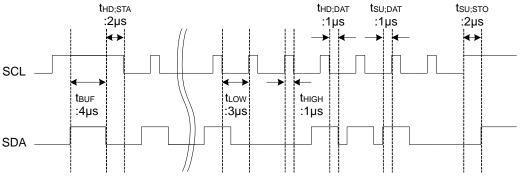
All values refer to VIH Min and VIL Max Levels (see Table 2).

(Note) A device must internally provide a hold time of at least 300 ns for the SDA signal (referred to the VIH Min of the SCL signal) in order to bridge the undefined region of the falling edge of SCL.

For 7(t_{HD:DAT}), 8(t_{SU:DAT}), make the setup in which the margin is full.

Table 2 Characteristics of the SDA and SCL I/O stages for I²C-bus devices

	Parameter	Cumbal	Fast-mode	e devices	Unit
	Farameter	Symbol	Min	Max	Offit
10	LOW level input voltage:	VIL	-0.3	+1	V
11	HIGH level input voltage:	V _{IH}	2.3	5	V
12	Pulse width of spikes which must be suppressed by the input filter.	t sp	0	50	ns
13	LOW level output voltage: at 3mA sink current	V _{OL1}	0	0.4	V
14	Input current each I/O pin with an input voltage between 0.4V and 4.5V.	II	-10	+10	μΑ



SCL clock frequency: 250kHz

Figure 23. A Command Timing Example in the I²C Data Transmission

(2) <u>I²C BUS FORMAT</u>

		MSB LSB		MSB L	SB	MSB L	.SB			
	S	Slave Address	Α	Select Address	Α	Data		Α	Р	
1	bit	8bit	1bit	8bit	1bit	8bit		1bit	1bit	
		S	= Sta	art condition (Recogi	nition of	start bit)				
		Slave Address	= Re	cognition of slave a	ddress.	The first 7 bits corres	spond	l to th	e slav	e address.
			Th	e least significant bit	is "L" w	hich corresponds to	write	mode	Э.	
		Α	= AC	KNOWLEDGE bit (I	Recognit	ion of acknowledger	ment)			
		Select Address	= Se	lect address corresp	onding t	o volume, bass or ti	reble.			
		Data	= Da	ta on every volume	and tone).				
		Р	= Sto	op condition (Recogi	nition of	stop bit)				

(3) I²C BUS Interface Protocol

(a) Basic Format

S	Slave Addre	ss	Α	Select Addre	Α	Data	Α	Р	
	MSB	LSB		MSB	LSB	١	1SB L	SB	

(b) Automatic Increment (Select Address increases (+1) according to the number of data.)

S	Slave Address	Α	Select Add	ress	Α	Data1	Α	Data2	Α		DataN	Α	Р
	MSB LSB		MSB	LSB		MSB I	SB	MSB	LS	В	MSB	LS	SB

(Example) ①Data1 shall be set as data of address specified by Select Address.

- ②Data2 shall be set as data of address specified by Select Address +1.
- ③DataN shall be set as data of address specified by Select Address +N-1.

(c) Configuration Unavailable for Transmission (In this case, only Select Address1 is set.)

Г	SS	Slave Address	Α	Select	Address1	Α	Da	ata	Α	Select	Addres	s 2	Α	Da	ta	Α	Р
	M	SB L	.SB	MSB	LSB	M	SB	LSB	,	MSB		LSB	N	ISB	LSI	В	
		(Note) If ar	y dat	a is transr	mitted as Se	elect	t Ado	dress	2 n	ext to da	ıta, it is	recog	gniz	ed			
	(Note) If any data is transmitted as Select Address 2 next to data, it is recognized as data, not as Select Address 2.																

(4) Slave Address

MSB							LSB	
A6	A5	A4	A3	A2	A1	A0	R/W	
1	0	0	0	0	0	0	0	80H

(5) Select Address & Data

Items	Select Address	мѕв			Da	ata			LSB		
items	(hex)	D7	D6	D5	D4	D3	D2	D1	D0		
Initial setup 1	01	Advanced switch ON/OFF	0	Input Gai Tone/Fade	witch time of n/Volume r/Loudness ting	0	1 Advanced switch till of Mute				
Initial setup 2	02	LPF Phase	Level Meter RESET		er Output lect	0	Su	bwoofer LPI	= fc		
Initial setup 3	03	Front HPF Pass	Rear HPF Pass	Fro	nt/Rear HPI	F fc	0	1	0		
Input Selector	05	Full-diff Type	0	0		1	nput selecto	or			
Input gain	06	Mute ON/OFF	0	0	0 Input Gain						
Volume gain	20		Volume Gain / Attenuation								
Fader 1ch Front	28				Fader Gain	/ Attenuatior	1				
Fader 2ch Front	29		Fader Gain / Attenuation								
Fader 1ch Rear	2A		Fader Gain / Attenuation								
Fader 2ch Rear	2B				Fader Gain	/ Attenuatior)				
Fader Subwoofer	2C				Fader Gain	/ Attenuatior	1				
Mixing	30				Mixing Gain	/ Attenuation	n				
Bass setup	41	0	0	Bas	s fo	0	0	Bas	s Q		
Middle setup	44	0	0	Midd	lle fo	0	0	Midd	lle Q		
Treble setup	47	0	0	Treb	ole fo	0	0	0	Treble Q		
Bass gain	51	Bass Boost/ Cut	0	0	Bass Gain						
Middle gain	54	Middle Boost/ Cut	0	0	Middle Gain						
Treble gain	57	Treble Boost/ Cut	0	0	Treble Gain						
Loudness Gain	75	0	Loudness Hicut Loudness Gain								
System Reset	FE	1	0	0	0	0	0	0	1		

: Advanced switch

Note

- 1. The Advance Switch works in the latch part while changing from one function to another.
- Upon continuous data transfer, the Select Address rolls over because of the automatic increment function, as shown below.

$$01 \rightarrow 02 \rightarrow 03 \rightarrow 05 \rightarrow 06 \rightarrow 20 \rightarrow 28 \rightarrow 29 \rightarrow 2A \rightarrow 2B \rightarrow 2C$$

$$30 \rightarrow 41 \rightarrow 44 \rightarrow 47 \rightarrow 51 \rightarrow 54 \rightarrow 57 \rightarrow 75$$

- 3. Advanced switch is not used for the function of input selector and subwoofer output select, etc. Therefore, please apply mute on the side when changing these settings.
- 4. When using mute function of this IC at the time of changing input selector, please switch mute ON/OFF for waiting advanced-mute time.

Select address 01 (hex)

Time	MSB	J ute	D0 0 1 1 0 1					
Time	D7	D6	D5	D4	D3	D2	D1	D0
0.6msec	A di (2)2 2 2 d		Advanced	switch time			0	0
1.0msec	Advanced Switch	0	of Input g	ain/Volume	^	1	0	1
1.4msec	ON/OFF	U	Tone/Fade	er/Loudness	U	1	1	0
3.2msec	ON/OFF		Mi	xing			1	1

Time	MSB	Advanced switch time of Input gain/Volume/Tone/Fader/ LSB Loudness/Mixing								
	D7	D6	D5	D4	D3	D2	D1	D0		
4.7 msec	A al. (2 2 2 2 2 d		0	0						
7.1 msec	Advanced	0	0	1	_	4	Advance	ed switch		
11.2 msec	Switch ON/OFF			U	1	0	1 0	1	Time	of Mute
14.4 msec			1	1						

Mode	MSB	D7 D6 D5 D4 D3 D2 D1 0 Advanced switch time of Input gain/Volume Tone/Fader/Loudness 0 1 Advanced Advanced Advanced Advanced Switch time Of Input gain/Volume Tone/Fader/Loudness	LSB					
Mode	D7	D6	D5	D4	D3	D2	D1	D0
OFF	0	0	of Input gain/Volume		0	1		ed switch
ON	1			er/Loudness xing	Ü		Time o	of Mute

Select address 02(hex)

f	MSB			LSB				
tc	D7	D6	D6 D5 D4 D3 D2				D1	D0
OFF						0	0	0
55Hz		Laural				0	0	1
85Hz	LPF	Level	Subwoof	er Output	0	0	1	0
120Hz	Phase	Meter RESET	Sel	ect	U	0	1	1
160Hz		KESET				1	0	0
Prohibition						(Other setting	9

Mode	MSB	;	Subwo	oofer (Dutput	Selec	ct	LSB	
	D7	D6	D5	D4	D3	D2	D1	D0	
LPF			0	0					
Front	LPF	Level	0	1				- ,	
Rear	Phase	Meter	1	0	0	Su	bwoofer LPI	r fc	
Prohibition		RESET	1	1					

Mode	MSB		Lev	el Met	er RE	SET	D1 D0 Dwoofer LPF fc			
Mode	D7	D6	D5	D4	D3	D2	D1	D0		
HOLD	LPF	0	Subwoof	er output	0	C	ha afa a I D	- 1		
RESET	Phase	1	select		U	Su	bwooier LP	F IC		

Phase	MSB			LPF I	Phase	!		LSB
Filase	D7	D6	D5	D4	D3	D2	D1	D0
0°	0	Level	Subwoof	er output	0	Ç.,	bwoofor LD	⊏ fo
180°	1	Meter RESET	sel	ect	0	Su	Subwoofer LPF	r IC

Select address 03(hex)

MSB		Fro	nt/Rea	nt/Rear HPF fc				
D7	D6	D5	D4	D3	D2	D1	D0	
		0	0	0				
Front	Rear	0	0	1				
Front HPF	HPF	1	1	0	0	1	D0 0	
Pass	Pass	0	1	0		-		
		(Other setting	9				
	D7 Front HPF	D7 D6 Front Rear HPF HPF	D7 D6 D5 0 0 Front HPF HPF HPF Pass 1 Pass 0	D7 D6 D5 D4 0 0 0 Front HPF HPF Pass 1 1 Pass 0 1	D7 D6 D5 D4 D3 0 0 0 0 Front HPF 1 1 0	D7 D6 D5 D4 D3 D2 Front HPF HPF Pass 0 0 1 0 <td>D7 D6 D5 D4 D3 D2 D1 Front HPF HPF HPF Pass Rear HPF Pass 0 0 1 0 0 1 Pass 0 1 0 0 1 0 0 1</td>	D7 D6 D5 D4 D3 D2 D1 Front HPF HPF HPF Pass Rear HPF Pass 0 0 1 0 0 1 Pass 0 1 0 0 1 0 0 1	

Mode	MSB			Rear	HPF			LSB
Mode	D7	D6	D5	D4	D3	D2	D1	D0
pass	Front HPF	0	Fro	ont/Rear HP	F fc	0	1	0
NOT pass	Pass	1		ong roar in	1 10			

Mode	MSB		Front HPF						
Wiode	D7	D6	D5	D4	D3	D2	D1	D0	
pass	0	Rear HPF	Er,	ont/Rear HPI	⊏ fo	0	1	0	
NOT pass	1	Pass	FIC	nivreal nri	r IC	0	'	U	

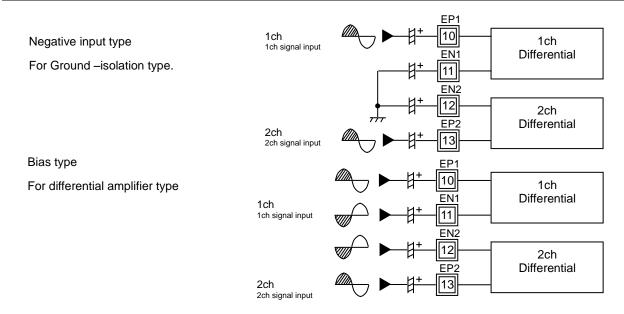
Select address 05(hex)

		MSB		L	nnut S	LSB			
- · · · · ·						1	1		
OUTF1	OUTF2	D7	D6	D5	D4	D3	D2	D1	D0
A1	A2				0	0	0	0	0
B1	B2				0	0	0	0	1
C1	C2				0	0	0	1	0
DP1	DP2				0	0	0	1	1
EP1	EN1	Full-			0	1	0	1	0
EN2	EP2	diff bias	0	0	0	1	0	1	1
A1	B1	type	U	U	0	1	1	1	1
B2	C2	select			1	0	0	0	0
DP1	DP2				0	0	1	1	0
EP1	EP2				0	1	0	0	0
t SHOR	Τ				0	1	0	0	1
Prohibition					Other setting				
	B1 C1 DP1 EP1 EN2 A1 B2 DP1 EP1 t SHOR	A1 A2 B1 B2 C1 C2 DP1 DP2 EP1 EN1 EN2 EP2 A1 B1 B2 C2 DP1 DP2 EP1 EP2 t SHORT	OUTF1 OUTF2 D7 A1 A2 B1 B2 C1 C2 DP1 DP2 EP1 EN1 EN2 EP2 A1 B1 B2 C2 DP1 DP2 EP1 DP2 EP1 EP2 t SHORT	OUTF1 OUTF2 D7 D6 A1 A2 B1 B2 C1 C2 DP1 DP2 EP1 EN1 EN2 EP2 A1 B1 B2 C2 DP1 DP2 EP1 DP2 EP1 EP2 t SHORT	OUTF1 OUTF2 D7 D6 D5 A1 A2 B1 B2 C1 C2 DP1 DP2 EP1 EN1 EN2 EP2 A1 B1 B2 C2 DP1 DP2 EP1 EP2 t SHORT OUTF2 D7 D6 D5 O 0 O 0 O 0 O 0 O 0 O 0 O 0 O	OUTF1 OUTF2 D7 D6 D5 D4 A1 A2 B1 B2 C1 C2 DP1 DP2 EP1 EN1 EN2 EP2 A1 B1 B2 C2 DP1 DP2 EP1 DP2 EP1 EP2 t SHORT OUTF2 D7 D6 D5 D4 O 0 O 0 O 0 O 0 O 0 O 0 O 0 O 0 O 0 O	OUTF1 OUTF2 D7 D6 D5 D4 D3 A1 A2 B1 B2 C1 C2 DP1 DP2 EP1 EN1 EN2 EP2 A1 B1 B2 C2 DP1 DP2 EP1 EP2 t SHORT OUTF2 D7 D6 D5 D4 D3 O 0 O O O O O O O O O O O O O O O O O	OUTF1 OUTF2 D7 D6 D5 D4 D3 D2 A1 A2 B1 B2 C1 C2 DP1 DP2 EP1 EN1 EN2 EP2 A1 B1 B2 C2 DP1 DP2 EP1 EP2 t SHORT OUTF2 D7 D6 D5 D4 D3 D2 O 0 0 0 O 0 0	OUTF1 OUTF2 D7 D6 D5 D4 D3 D2 D1 A1 A2 B1 B2 C1 C2 DP1 DP2 EP1 EN1 EN2 EP2 A1 B1 B2 C2 DP1 DP2 EP1 EP2 EP1 EP2 tsHORT

Input SHORT : The input impedance of each input terminal is lowered from 100kΩ(Typ) to 6 kΩ(Typ). (For quick charge of coupling capacitor)

Select address 05(hex)

Mode	MSB Full-diff Bias Type Select								
iviode	D7	D6	D5	D4	D3	D2	D1	D0	
Negative Input	0	0	0		1	anut Calaata			
Bias	1] 0	0	Input Selector					



Select address 06 (hex)

Mode	MSB			Input	Gain			LSB	
Mode	D7	D6	D5	D4	D3	D2	D1	D0	
0dB				0	0	0	0	0	
1dB				0	0	0	0	1	
2dB				0	0	0	1	0	
3dB				0	0	0	1	1	
4dB				0	0	1	0	0	
5dB				0	0	1	0	1	
6dB				0	0	1	1	0	
7dB				0	0	1	1	1	
8dB					0	1	0	0	0
9dB				0	1	0	0	1	
10dB				0	1	0	1	0	
11dB	Mute	0	0	0	1	0	1	1	
12dB	ON/OFF	U	0	0	1	1	0	0	
13dB				0	1	1	0	1	
14dB				0	1	1	1	0	
15dB				0	1	1	1	1	
16dB				1	0	0	0	0	
17dB				1	0	0	0	1	
18dB				1	0	0	1	0	
19dB				1	0	0	1	1	
20dB				1	0	1	0	0	
				1	1	0	1	1	
Prohibition					:	:	÷	:	
				1	1	1	1	1	

Select address 06 (hex)

Mode	MSB	MSB Mute ON/OFF								
IVIOGE	D7	D6	D5	D4	D3	D2	D1	D0		
OFF	0	0	0			Input Gain				
ON	1	0	U			Input Gain				

Select address 20, 28, 29, 2A, 2B, 2C (hex)

Gain & ATT	MSB	Vo	I, Fad	er Gai	n / Att	enuat	ion	LSB
Gairia Airi	D7	D6	D5	D4	D3	D2	D1	D0
	0	0	0	0	0	0	0	0
	0	0	0	0	0	0	0	1
Prohibition	:	:	:	:	:	:	:	:
	0	1	1	1	0	0	0	0
15dB	0	1	1	1	0	0	0	1
14dB	0	1	1	1	0	0	1	0
13dB	0	1	1	1	0	0	1	1
:	:	:	:	:	:	:	:	:
-77dB	1	1	0	0	1	1	0	1
-78dB	1	1	0	0	1	1	1	0
-79dB	1	1	0	0	1	1	1	1
	1	1	0	1	0	0	0	0
Prohibition	:	:	:	:	:	÷	:	:
	1	1	1	1	1	1	1	0
-∞dB	1	1	1	1	1	1	1	1

Select address 30(hex)

Select address 30(ne.	MSB	I	Mixing	Gain	/ Atte	nuatio	n	LSB
Gain & ATT	D7	D6	D5	D4	D3	D2	D1	D0
	0	0	0	0	0	0	0	0
	0	0	0	0	0	0	0	1
Prohibition	:	:	:	:	:	:	:	:
	0	1	1	1	1	0	0	0
7dB	0	1	1	1	1	0	0	1
6dB	0	1	1	1	1	0	1	0
5dB	0	1	1	1	1	0	1	1
:	:	:	:	:	:	:	:	:
-77dB	1	1	0	0	1	1	0	1
-78dB	1	1	0	0	1	1	1	0
-79dB	1	1	0	0	1	1	1	1
	1	1	0	1	0	0	0	0
Prohibition	:	:	:	:	:	:	:	:
	1	1	1	1	1	1	1	0
MIX OFF	1	1	1	1	1	1	1	1

Select address 41(hex)

Q factor	MSB		В	ass	Q fact	or		LSB
Q lactor	D7	D6	D5	D4	D3	D2	D1	D0
0.5			Dogs f		0	0	0	0
1.0	0	0					0	1
1.5	U	0	Das	Bass f ₀			1	0
2.0							1	1

f -	MSB		Bass f _O						
IO	D7	D6	D5	D4	D3	D2	D1	D0	
60Hz			0	0			·		
80Hz]	_	0	1	_	0	Ва	ass actor	
100Hz] 0		1	0	0	U	Q fa	actor	
120Hz			1	1					

Select address 44(hex)

Soloot address 11(110X	,							
Q factor	MSB		Mi	Middle		Q factor		LSB
QTactor	D7	D6	D5	D4	D3	D2	D1	D0
0.75						0	0	0
1.0	_	0	Mida	Middle fo			0	1
1.25			iviido	JIE IU	0	U	1	0
1.5						1	1	

f	MSB			Middl	LSB			
IO	D7	D6	D5	D4	D3	D2	D1	D0
500Hz			0	0				
1kHz		0	0	1	_	_	Mic	ddle actor
1.5kHz] 0	U	1	0	0	U	Q fa	actor
2.5kHz			1	1	1			

Select address 47 (hex)

Q factor	MSB		Tre	Treble		tor		LSB
Q lactor	D7	D6	D5	D4	D3	D2	D1	D0
0.75	0	0	Troh	ole f _O	0	0	0	0
1.25	U	U	Het	01 30	U	U	U	1

fo	MSB Treble fo							
10	D7	D6	D5	D4	D3	D2	D1	D0
7.5kHz			0	0				
10kHz	0	0	0	1	0	0	0	Treble
12.5kHz	U	U	1	0	U	U	0	Q factor
15kHz			1	1				

Select address 51, 54, 57 (hex)

Coin	MSB	E	3ass/N	/liddle	/Trebl	e Gair	1	LSB
Gain	D7	D6	D5	D4	D3	D2	D1	D0
0dB				0	0	0	0	0
1dB				0	0	0	0	1
2dB				0	0	0	1	0
3dB				0	0	0	1	1
4dB				0	0	1	0	0
5dB				0	0	1	0	1
6dB				0	0	1	1	0
7dB				0	0	1	1	1
8dB				0	1	0	0	0
9dB			0	0	1	0	0	1
10dB	Bass/			0	1	0	1	0
11dB	Middle/			0	1	0	1	1
12dB	Treble	0		0	1	1	0	0
13dB	Boost			0	1	1	0	1
14dB	/cut	cut		0	1	1	1	0
15dB				0	1	1	1	1
16dB				1	0	0	0	0
17dB				1	0	0	0	1
18dB				1	0	0	1	0
19dB				1	0	0	1	1
20dB				1	0	1	0	0
				1	0	1	0	1
Prohibition				:	:	:		:
FIUIIIDILIUII				1	1	1	1	0
				1	1	1	1	1

Mada	MSB	ISB Bass/Middle/Treble Boost/Cut							
Mode	D7	D6	D5	D4	D3	D2	D1	D0	
Boost	0	0	0		Page/Middle/Troble Coin				
Cut	1	U	0 Bass/Middle/Treble Gain						

Select address 75 (hex)

Ocicol addices 10 (ile)	')							
Mode	MSB L			oudne	LSB			
iviode	D7	D6	D5	D4	D3	D2	D1	D0
Hicut1		0	0					
Hicut2	_	0	1		in			
Hicut3	U	1	0		L	oudness Ga	III)	
Hicut4		1	1					

Gain	MSB		Lo	oudne	ss Ga	in		LSB
Gain	D7	D6	D5	D4	D3	D2	D1	D0
0dB				0	0	0	0	0
1dB				0	0	0	0	1
2dB				0	0	0	1	0
3dB				0	0	0	1	1
4dB				0	0	1	0	0
5dB				0	0	1	0	1
6dB				0	0	1	1	0
7dB				0	0	1	1	1
8dB				0	1	0	0	0
9dB				0	1	0	0	1
10dB				0	1	0	1	0
11dB	0	Loudness Hicut	se Hicut	0	1	0	1	1
12dB	U		Loddinood i nodt	0	1	1	0	0
13dB				0	1	1	0	1
14dB				0	1	1	1	0
15dB				0	1	1	1	1
16dB				1	0	0	0	0
17dB				1	0	0	0	1
18dB				1	0	0	1	0
19dB				1	0	0	1	1
20dB				1	0	1	0	0
				1	0	1	0	1
Prohibition					÷		•	:
				1	1	1	1	1

: Initial condition

(6) About Power ON Reset

Built-in IC initialization is made during power ON of the supply voltage. Please send initial data to all addresses at supply voltage on. And please turn ON mute until this initial data is sent.

Darameter	Cumbal		Limit		Lloit	Conditions
Parameter	Symbol	Min	Тур	Max	Unit	Conditions
Rise Time of VCC	t _{RISE}	33	-	-	µsec	V _{CC} rise time from 0V to 5V
VCC Voltage of Release Power ON Reset	V _{POR}	-	4.1	-	V	

(7) About External Compulsory Mute Terminal

It is possible to force mute externally by setting an input voltage to the MUTE terminal.

Mute Voltage Condition	Mode
GND to 1.0V	MUTE ON
2.3V to Vcc	MUTE OFF

Establish the voltage of MUTE in the condition you want to set.

Application Information

1. Function and Specifications

ction and Speci	fications										
Function	Specifications										
	Stereo inpu	t									
	· Single-End/										
	(Possible to se	et the number of									
Input	Mode 1	Single-End 0	Differential 3	Full-Differential 1							
selector	Mode 2	1	2	1							
	Mode 3	3	1	1							
	Mode 4 Mode 5	<u>4</u> 5	<u> </u>	0							
	Mode 6	6	0	0							
		Table.1 Combi	nation of input se	elector							
Input gain	· +20dB to 0d	dB (1dB step)									
Input gain	· Possible to	use "Advanced s	witch" for preven	tion of switching noise.							
Mute	· Possible to	use "Advanced s	witch" for prevent	tion of switching noise.							
Volume	· +15dB to -7	9dB (1dB step),	-∞dB								
VOIGITIE	· Possible to	use "Advanced s	witch" for prevent	tion of switching noise.							
		0dB (1dB step)									
Bass	· Q=0.5, 1, 1.5, 2										
2400	· f ₀ =60, 80, 100, 120Hz										
	Possible to use "Advanced switch" for prevention of switching noise.										
	· +20dB to -20dB (1dB step)										
Middle	· Q=0.75, 1, 1.25, 1.5										
ivildale	· fo=500, 1k, 1.5k 2.5kHz										
	· Possible to use "Advanced switch" for prevention of switching noise.										
	· +20dB to -20dB (1dB step)										
Treble	· Q=0.75, 1.25										
Treble	· fo=7.5k, 10l	k, 12.5k, 15kHz									
	· Possible to	use "Advanced s	witch" for preven	tion of switching noise.							
Fader	· +15dB to -7	9dB(1dB step), -	∞dB								
- auci	· Possible to	use "Advanced s	witch" for prevent	tion of switching noise.							
Loudness	· 20dB to 0dB	3(1dB step)									
	· Possible to	use "Advanced s	witch" for prevent	tion of switching noise.							
LPF		0Hz/160Hz, pass	5								
	· Phase shift										
HPF		· f _C =55/85/120Hz/160Hz, pass									
Level meter	· I ² C BUS co	ntrol									
	· DC Output										
	 Monaural in 	put									
Mixing	· +7dB to -79dB (1dB step), -∞dB										
	· Possible to	use "Advanced s	witch" for prevent	tion of switching noise.							

2. Volume / Fader Volume / Mixing Attenuation Data

+15	(dB)	D7	D6	D5	D4	D3	D2	D1	D0	(dB)	D7	D6	D5	D4	D3	D2	D1	D0
#14	+15	0	1	1	1	0	0	0	1	-33	1	0	1	0	0	0	0	1
+13 0 1 1 1 0 0 1 1 1 +12 0 1 1 0 0 1 1 1 0 0 0 1 1 1 0 0 0 1 1 0 0 1 0 1 0 1 1 1 0 0 1 1 1 0 1 1 1 0 0 1 1 1 0 0 0 1 1 1 0 0 0 1 1 1 1 0 0 0 1 1 1 1 0 0 0 1 <td></td> <td></td> <td>1</td> <td>1</td> <td>1</td> <td>0</td> <td>0</td> <td>1</td> <td>0</td> <td></td> <td>1</td> <td>0</td> <td>1</td> <td>0</td> <td>0</td> <td>0</td> <td>1</td> <td></td>			1	1	1	0	0	1	0		1	0	1	0	0	0	1	
+12 0 1 1 1 0 1 0 0 0 -37 1 0 1 0 0 0 -37 1 0 1 0 0 1 0 0 1 1 0 0 1 1 0 0 1 1 0 0 1 1 0 0 1 1 1 0 0 0 1 1 1 0 0 0 0 1 1 1 0<			1	1	1	0	0	1			1	0	1	0	0	0	1	
H11			1		1	0	1	0			1	0	1	0		1	0	
+10			1		1	0	1				1	0	1	0	0	1	0	
+9 0 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 0 0 0 1 1 1 1 1 0 0 0 0 1 0 0 0 0 0 1 1 44 1 0 1 1 0 1 1 1 44 1 0 <td></td> <td></td> <td>1</td> <td>1</td> <td>1</td> <td>0</td> <td>1</td> <td>1</td> <td></td> <td></td> <td>1</td> <td>0</td> <td>1</td> <td>0</td> <td>0</td> <td>1</td> <td>1</td> <td></td>			1	1	1	0	1	1			1	0	1	0	0	1	1	
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Mixing Adjustable range is +7dB to -∞dB.								0	0	-∞	1	1	1	1	1	1	1	1

Mixing Adjustable range is +7dB to -∞dB.

(1) About Level Meter

(a) The Operation of Circuit

The level meter is a function which gives a DC voltage proportional to the size of the sound signal. It detects the peak level of the signal and keeps that peak level, so that it is possible to monitor the size of the signal by resetting the DC voltage kept with suitable interval.

(b) The Way to Reset Level Meter Output

Please send reset data through I2C BUS

How to reset output of level meter: Send D6 = "1" to select address 02(hex).

How to cancel output reset of level meter (HOLD): Send D6 = "0" to select address 02(hex).

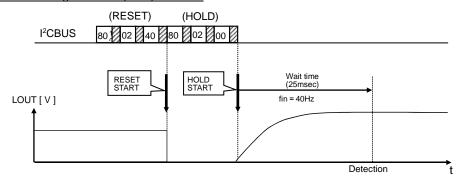
(c) The Settings About Reset Period

Peak hold operation will start after HOLD data is transmitted. Set the WAIT time after HOLD data transmission according to the frequency bandwidth detected.

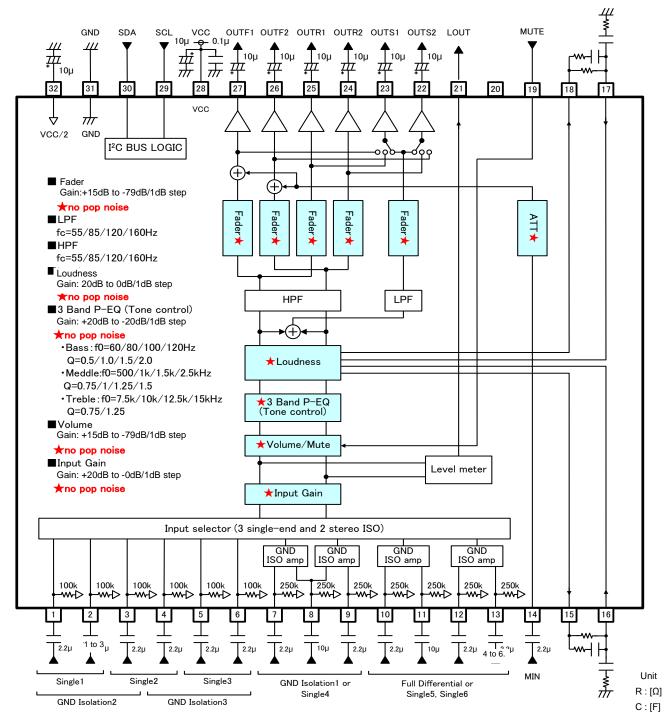
WAIT time must be set to a minimum of one cycle over the detected frequency bandwidth.

Ex) Detected frequency bandwidth is above 40Hz, \$\t^240Hz = 25ms = WAIT time_{\text{\text{I}}}\$

Transmission Diagram Example by I2C BUS



3. Application Circuit



 $\% About single input 1 {\sim} 3, it is possible to change from single input to GND Isolation input 2,3.$

%About GND Isolation1 and Full Differential, it is possible to change from differential input to single input 4 \sim 6.

Notes on wiring

- ①Please connect the decoupling capacitor of the power supply in the shortest possible distance to GND.
- 2GND lines should be one-point connected.
- Wiring pattern of Digital should be away from that of Analog unit and cross-talk should not be acceptable.
- 4)SCL and SDA lines of I²C BUS should not be parallel if possible.
- The lines should be shielded, if they are adjacent to each other.
- ⑤Analog input lines should not be parallel if possible. The lines should be shielded, if they are adjacent to each other.

Power Dissipation

About the thermal design of the IC

Characteristics of an IC have a great deal to do with the temperature at which it is used, and exceeding absolute maximum ratings may degrade and destroy elements. Careful consideration must be given to the heat of the IC from the two standpoints of immediate damage and long-term reliability of operation.

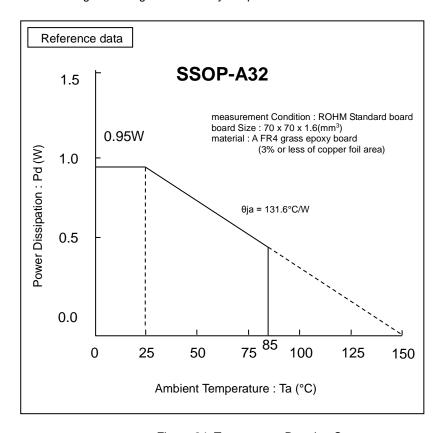


Figure 24. Temperature Derating Curve

(Note) Values are actual measurements and are not guaranteed. Power dissipation values vary according to the board on which the IC is mounted.

I/O Equivalent Circuits

Terminal No.	Terminal Name	Terminal	Equivalent Circuit	Terminal Description
1 2 3 4 5 6	A1 A2 B1 B2 C1 C2	Voltage 4.25	VCC O Δ Ø Ø MO Ø Ø Ø Ø Ø Ø Ø Ø Ø Ø Ø Ø Ø	A terminal for signal input. The input impedance is 100kΩ(Typ).
7 8 9 10 11 12 13	DP1 DN DP2 EP1 EN1 EN2 EP2	4.25	VCC VΘ VΘ S250kΩ	Input terminal available to Single/Differential mode. The input impedance is 250kΩ(Typ).
15 18	LDA1 LDA2	4.25	VCC O 1.65V	The loudness characteristic setting terminal.
16 17	LDB1 LDB2	4.25	VCC A GND	The loudness characteristic setting terminal.
19	MUTE	-	VCC 0.58×V _{CC} \$ 250kΩ 1.65V	A terminal for external compulsory mute. If terminal voltage is High level, the mute is off. And if the terminal voltage is Low level, the mute is on.

Values in the pin explanation and input/output equivalent circuit are reference values only and are not guaranteed.

I/O Equivalent Circuits -continued

Terminal No.	Terminal Name	Terminal Voltage	Equivalent Circuit	Terminal Description
22 23 24 25 26 27	OUTS2 OUTS1 OUTR2 OUTR1 OUTF2 OUTF1	4.25	VCC BY	A terminal for fader and Subwoofer output.
28	VCC	8.5		Power supply terminal.
21	LOUT	0 to 3.3	VCC A STORY OF THE	A terminal for level meter output. Output impedance is 10kΩ(typ).
29	SCL	-	VCC O 1.65V	A terminal for clock input of I ² C BUS communication.
30	SDA	-	VCC O GND GND 1.65V	A terminal for data input of I ² C BUS communication.
31	GND	0		Ground terminal.
32	FIL	4.25	VCC 50k 50k	1/2 VCC terminal. Voltage for reference bias of analog signal system. The simple precharge circuit and simple discharge circuit for an external capacitor are built in.

Values in the pin explanation and input/output equivalent circuit are reference values only and are not guaranteed.

I/O Equivalent Circuits - continued

' `	Lquivaic	int On Cuits	- continue	u	
	Terminal No.	Terminal Name	Terminal Voltage	Equivalent Circuit	Terminal Description
	14	MIN	4.25	VCC VE VE VE VE VE VE VE VE VE VE	A terminal for signal input. The input impedance is $27k\Omega$ (Typ).

Values in the pin explanation and input/output equivalent circuit are reference values only and are not guaranteed.

Operational Notes

1. Reverse Connection of Power Supply

Connecting the power supply in reverse polarity can damage the IC. Take precautions against reverse polarity when connecting the power supply, such as mounting an external diode between the power supply and the IC's power supply pins.

2. Power Supply Lines

Design the PCB layout pattern to provide low impedance supply lines. Separate the ground and supply lines of the digital and analog blocks to prevent noise in the ground and supply lines of the digital block from affecting the analog block. Furthermore, connect a capacitor to ground at all power supply pins. Consider the effect of temperature and aging on the capacitance value when using electrolytic capacitors.

3. Ground Voltage

Ensure that no pins are at a voltage below that of the ground pin at any time, even during transient condition.

4. Ground Wiring Pattern

When using both small-signal and large-current ground traces, the two ground traces should be routed separately but connected to a single ground at the reference point of the application board to avoid fluctuations in the small-signal ground caused by large currents. Also ensure that the ground traces of external components do not cause variations on the ground voltage. The ground lines must be as short and thick as possible to reduce line impedance.

5. Thermal Consideration

Should by any chance the power dissipation rating be exceeded the rise in temperature of the chip may result in deterioration of the properties of the chip. In case of exceeding this absolute maximum rating, increase the board size and copper area to prevent exceeding the Pd rating.

6. Recommended Operating Conditions

These conditions represent a range within which the expected characteristics of the IC can be approximately obtained. The electrical characteristics are guaranteed under the conditions of each parameter.

7. Inrush Current

When power is first supplied to the IC, it is possible that the internal logic may be unstable and inrush current may flow instantaneously due to the internal powering sequence and delays, especially if the IC has more than one power supply. Therefore, give special consideration to power coupling capacitance, power wiring, width of ground wiring, and routing of connections.

8. Operation Under Strong Electromagnetic Field

Operating the IC in the presence of a strong electromagnetic field may cause the IC to malfunction.

9. Testing on Application Boards

When testing the IC on an application board, connecting a capacitor directly to a low-impedance output pin may subject the IC to stress. Always discharge capacitors completely after each process or step. The IC's power supply should always be turned off completely before connecting or removing it from the test setup during the inspection process. To prevent damage from static discharge, ground the IC during assembly and use similar precautions during transport and storage.

10. Inter-pin Short and Mounting Errors

Ensure that the direction and position are correct when mounting the IC on the PCB. Incorrect mounting may result in damaging the IC. Avoid nearby pins being shorted to each other especially to ground, power supply and output pin. Inter-pin shorts could be due to many reasons such as metal particles, water droplets (in very humid environment) and unintentional solder bridge deposited in between pins during assembly to name a few.

11. Unused Input Pins

Input pins of an IC are often connected to the gate of a MOS transistor. The gate has extremely high impedance and extremely low capacitance. If left unconnected, the electric field from the outside can easily charge it. The small charge acquired in this way is enough to produce a significant effect on the conduction through the transistor and cause unexpected operation of the IC. So unless otherwise specified, unused input pins should be connected to the power supply or ground line.

Operational Notes - continued

12. Regarding the Input Pin of the IC

This monolithic IC contains P+ isolation and P substrate layers between adjacent elements in order to keep them isolated. P-N junctions are formed at the intersection of the P layers with the N layers of other elements, creating a parasitic diode or transistor. For example (refer to figure below):

When GND > Pin A and GND > Pin B, the P-N junction operates as a parasitic diode.

When GND > Pin B, the P-N junction operates as a parasitic transistor.

Parasitic diodes inevitably occur in the structure of the IC. The operation of parasitic diodes can result in mutual interference among circuits, operational faults, or physical damage. Therefore, conditions that cause these diodes to operate, such as applying a voltage lower than the GND voltage to an input pin (and thus to the P substrate) should be avoided.

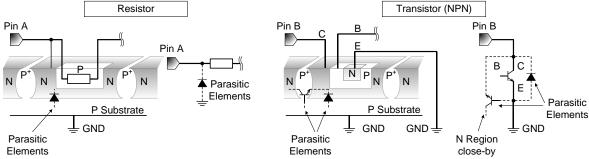
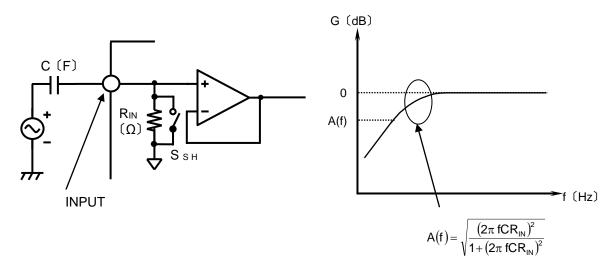


Figure 25. Example of monolithic IC structure

13. About Signal Input

(a) About Input Coupling Capacitor Constant Value

The constant value of input coupling capacitor C(F) is decided with respect to the input impedance $R_{IN}(\Omega)$ at the input signal terminal of the IC. The first HPF characteristic of RC is composed.



(b) About the Input Selector SHORT

SHORT mode is the command which makes switch S_{SH} =ON of input selector part so that the input impedance R_{IN} of all terminals becomes small. Switch S_{SH} is OFF when SHORT command is not selected. The constant time brought about by the small resistance inside and the capacitor outside the LSI becomes small when this command is used. The charge time of the capacitor becomes short. Since SHORT mode turns ON the switch of S_{SH} and makes it low impedance, please use it at no signal condition.

Operational Notes - continued

14. About Mute Terminal (Pin 19) when Power Supply is OFF

There should be no applied voltage across the Mute terminal (Pin 19) when power-supply is OFF. If in case voltage is supplied to mute terminal, please insert a series resistor (about $2.2k\Omega$) to Mute terminal. (Please refer to Application Circuit Diagram.)

15. About MIX

(1) About Specification of Fader -∞ at MIX ON.

Mix_signal is added to Main_signal after Fader_Gain(+15dB to -79dB) like the figure. When Fader is set at -∞, the signal after a MIX signal is added is done with MUTE because the -∞ circuit of Fader is in the step after the addition circuit

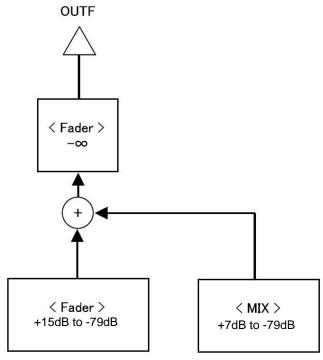
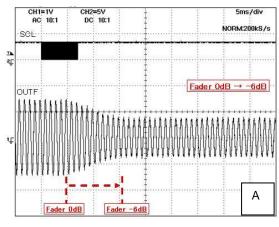


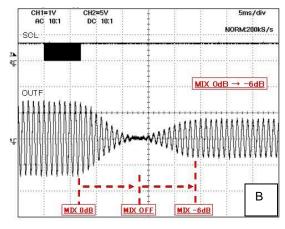
Figure 26. About Front Fader and MIX

(2) About Advanced Switching of MIX_Gain/ATT

When advanced switching of MIX_Gain/ATT works, MIX goes a switching movement that it passes through the state of MIX_OFF like in B figure below (from current setting of MIX_Gain/ATT to MIX_OFF to a target setting of MIX_Gain/ATT).



Fader_Gain/ATT 0dB to -6dB advanced switching



MIX_Gain/ATT 0dB to -6dB advanced switching

Figure 27. Advanced Switching Movement when MIX_Gain/ATT is Changed

Operational Notes - continued

16. About the External Parts Setting of Loudness Circuit

This IC is equipped with a Loudness circuit.

The Loudness gain is fixed inside the IC but its frequency characteristic can be changed freely by adjusting the external part filter. The circuit composition of the Loudness part is shown below. Incidentally, when not using the Loudness circuit, please short the pins between LDA1(Pin 15) and LDB1(Pin 16), and between LDA2(Pin 18) and LDB2(Pin 17), so as to avoid the inner amplifier inputs to become floating.

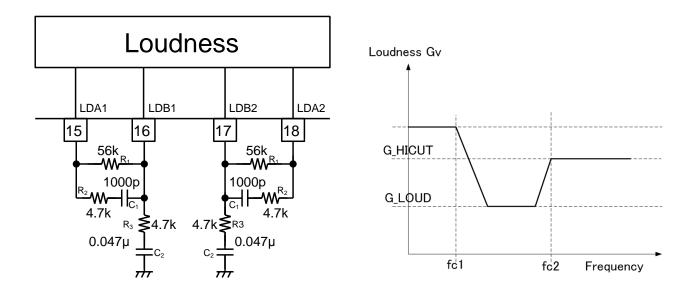


Figure 28. About the External Parts Setting of Loudness Circuit

The Loudness frequency characteristics are decided according to Figure 28. G_LOUD can be made 20dB when external parts used are the same with Figure 28 (the recommended value). G_LOUD is the amount of effect of Loudness when Loudness Gain is set at 20dB (P.22).

When Loudness frequency characteristics are changed, each parameter (Gain, Frequency) shown in Figure 28 can be decided using the following approximate equation below.

(Note) Design fc2 value more than one digit bigger than fc1 to get effect on Loudness.

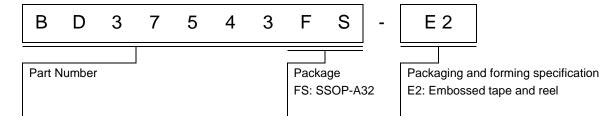
Loudness cut-off frequency

$$\begin{split} & fc1 = \frac{1}{2\pi C_2 (R_1 + R_3)} \quad \left[Hz \right] \\ & fc2 = \frac{1}{2\pi C_1 (R_2 + R_3)} \quad \left[Hz \right] \end{split}$$

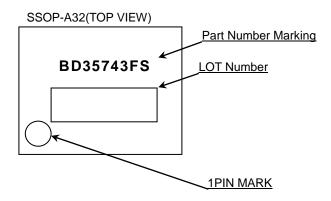
Loudness Gain (The amount of effect of Loudness)

$$\begin{split} \mathbf{G}_{_\mathsf{LOUD}} &= 20 \log \left(\frac{R_3}{R_1 + R_3} \right) \quad \big[\mathsf{dB} \big] \\ \mathbf{G}_{_\mathsf{HICUT}} &= 20 \log \left(\frac{R_3}{R_1 /\!\!/ R_2 + R_3} \right) \quad \big[\mathsf{dB} \big] \end{split}$$

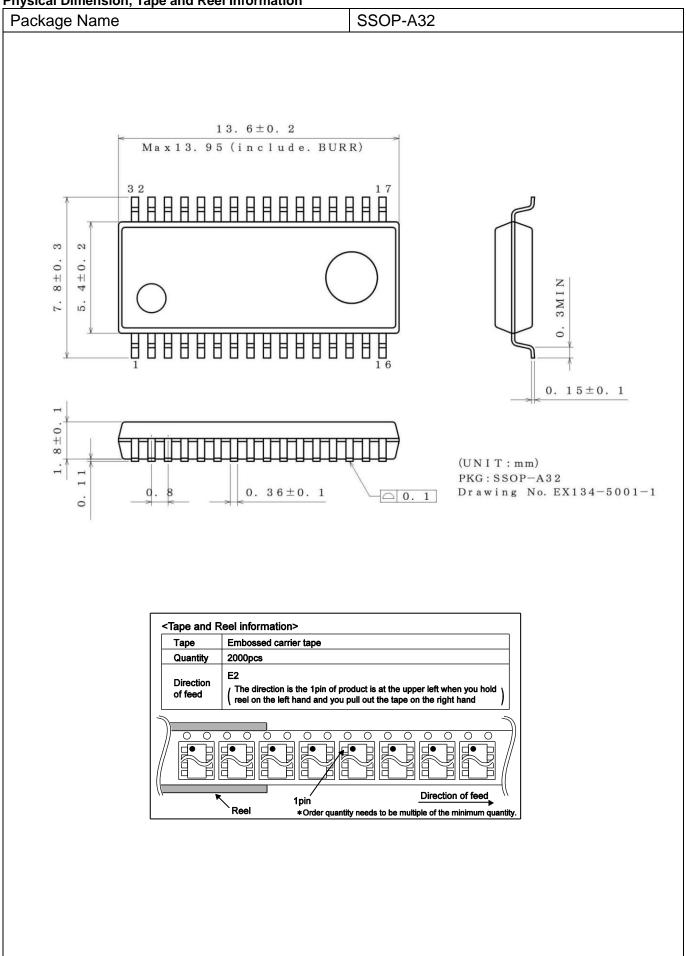
Ordering Information



Marking Diagram



Physical Dimension, Tape and Reel Information



Revision History

Date	Revision	Changes
16.Dec.2015	001	New Release

Notice

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(Note1) Medical Equipment Classification of the Specific Applications

JAPAN	USA	EU	CHINA
CLASSⅢ	CLASSII	CLASSIIb	CLASSIII
CLASSIV		CLASSⅢ	

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 - [b] Installation of redundant circuits to reduce the impact of single or multiple circuit failure
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 - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

Precautions Regarding Application Examples and External Circuits

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
- 2. You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
 may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
 exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

Precaution for Product Label

QR code printed on ROHM Products label is for ROHM's internal use only.

Precaution for Disposition

When disposing Products please dispose them properly using an authorized industry waste company.

Precaution for Foreign Exchange and Foreign Trade act

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BD37543FS - Web Page

Distribution Inventory

Part Number	BD37543FS
Package	SSOP-A32
Unit Quantity	2000
Minimum Package Quantity	2000
Packing Type	Taping
Constitution Materials List	inquiry
RoHS	Yes